

# Smart Watch

**Solution Proposal by Toshiba** 













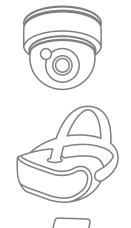
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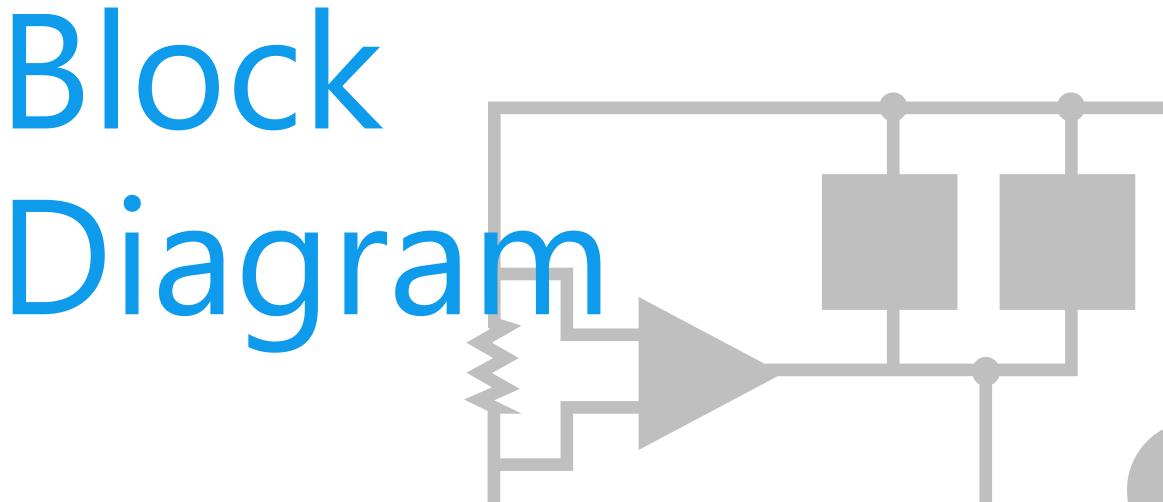






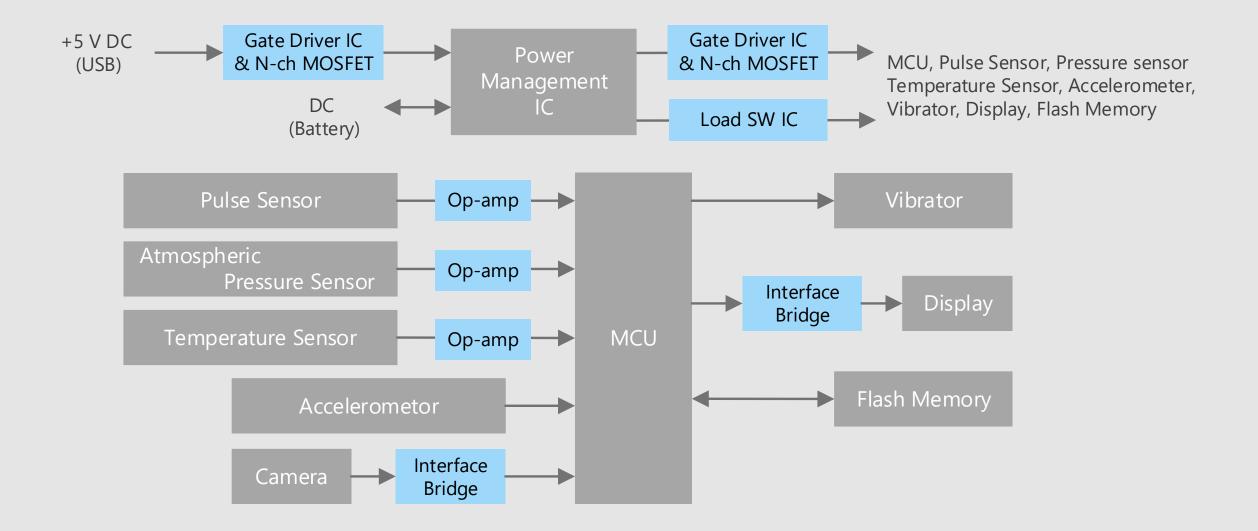
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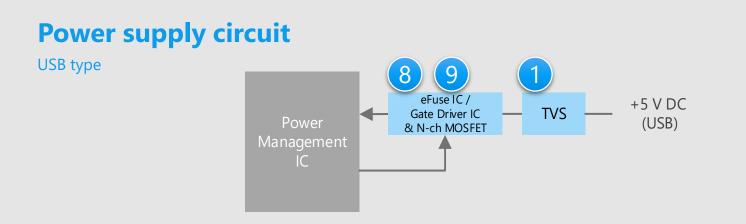


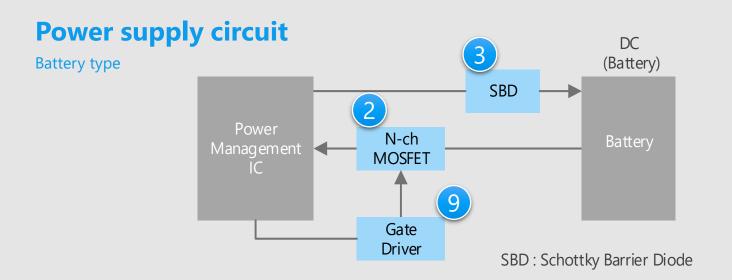
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# Smart Watch Overall block diagram



# Smart Watch Detail of power supply unit



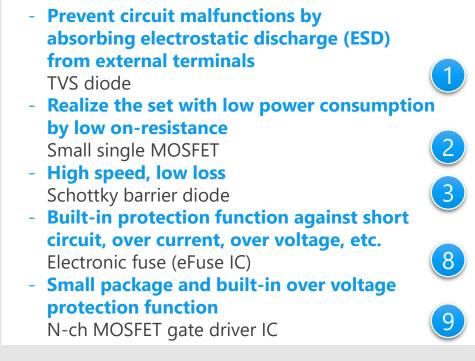


X Click on the blue circled numbers above to view detailed descriptions.

# Criteria for device selection

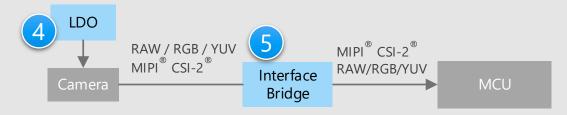
- MOSFETs with low on-resistance are suitable for the control of USB and battery powered supply circuits.
- TVS diodes are suitable for ESD protection of power line.

# **Proposal from Toshiba**

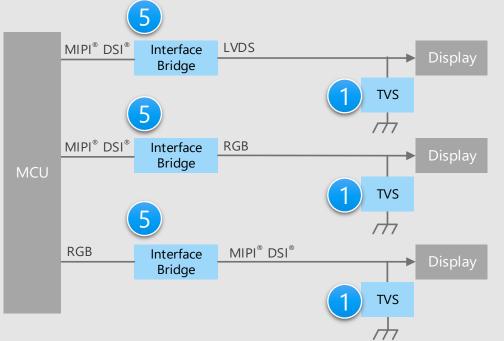


# Smart Watch Detail of peripheral unit

# **Camera input circuit**



**Display output circuit** 



※ Click on the blue circled numbers above to view detailed descriptions.

# Criteria for device selection

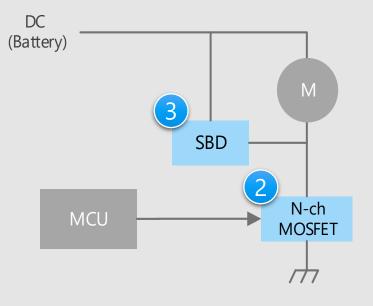
- PSRR (Power Supply Rejection Ratio) of LDO regulator is an important parameter for sensor modules.
- By using interface bridge, display and camera components can be selected without any concern for interface standards.

# Proposal from Toshiba

- Prevent circuit malfunctions by absorbing electrostatic discharge (ESD) from external terminals
   TVS diode
- Supply the power with low noise Small surface mount LDO regulator
- Absorb differences in interfaces Interface bridge

# Smart Watch Detail of motor control unit

# **Motor control for vibrators**



SBD : Schottky Barrier Diode

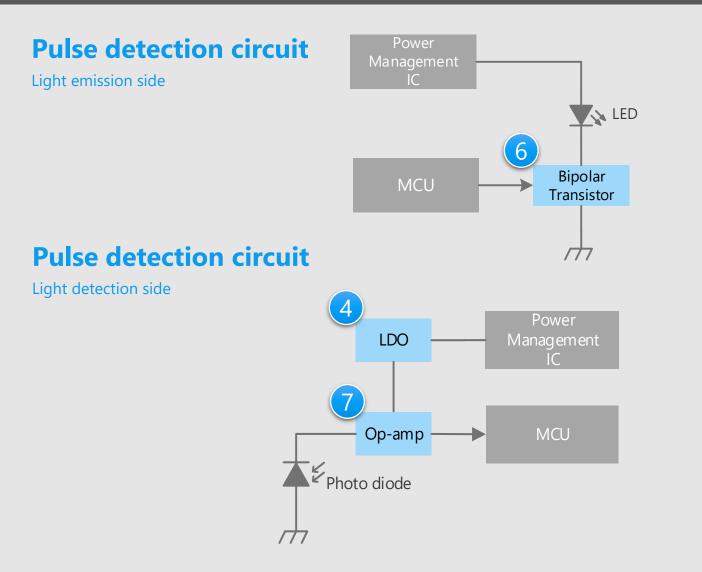
# Criteria for device selection

- MOSFETs with low on-resistance are suitable for motor driving.
- By using a Schottky barrier diode with low
   V<sub>F</sub> and low I<sub>R</sub>, the power consumption of
   the set can be reduced.

# Proposal from Toshiba

- The set with low power dissipation can be realized by low on-resistance Small signal MOSFET
- High speed, low loss Schottky barrier diode

# Smart Watch Detail of pulse detection unit



X Click on the blue circled numbers above to view detailed descriptions.

# Criteria for device selection

- Transistors with small package and low collector-emitter saturation voltage are required.
- PSRR (Power Supply Rejection Ratio) of LDO regulator is an important parameter for sensor modules.
- The operational amplifier should be low current consumption or low noise device.

# Proposal from Toshiba

- Small package, low V<sub>CE(sat)</sub>
   Bipolar transistor
- Supply the power with low noise
   Small surface mount LDO regulator
- Amplification of detected very small signal with low noise

Low current consumption op-amp / Low noise op-amp

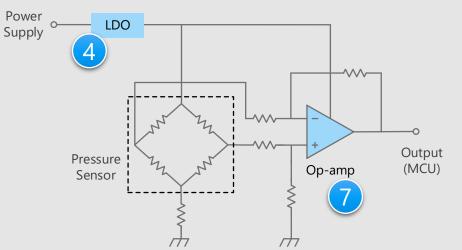


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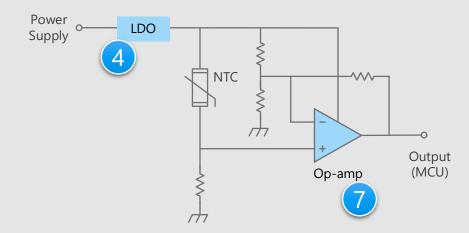
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# Smart Watch Detail of sensor units

# **Atmospheric pressure sensor circuit**



### **Temperature sensor circuit**



X Click on the blue circled numbers above to view detailed descriptions.

# Criteria for device selection

- PSRR (Power Supply Rejection Ratio) of LDO regulator is an important parameter for sensor modules.
- The operational amplifier should be low current consumption or low noise device.

# Proposal from Toshiba

- Supply the power with low noise Small surface mount LDO regulator
- 4
- Amplification of detected very small signal with low noise

Low current consumption op-amp / Low noise op-amp

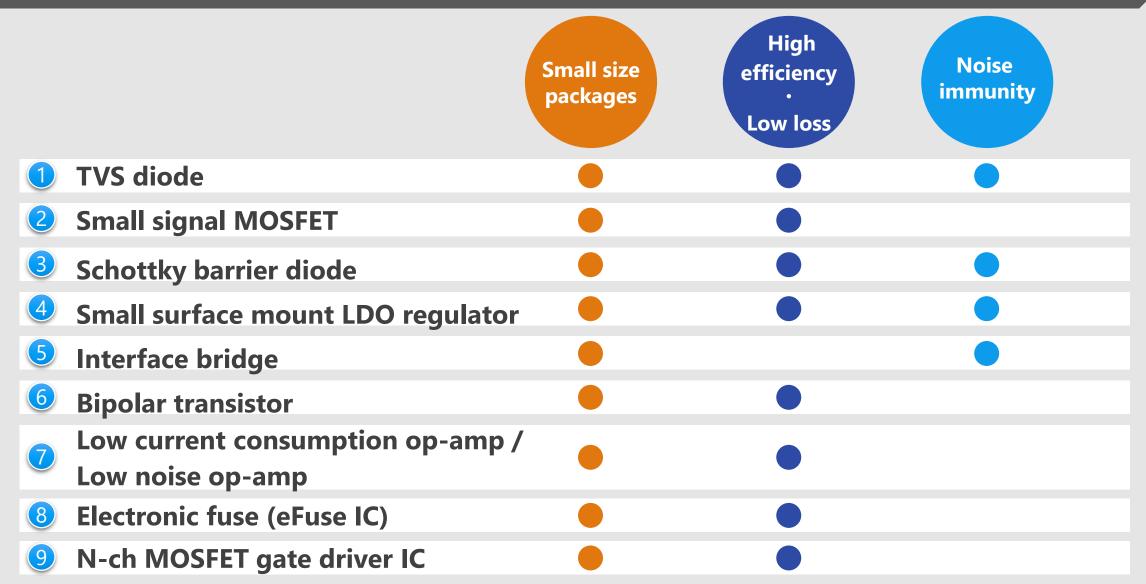
# Recommended Devices

# Device solutions to address customer needs

As described above, in the design of a smart watch, "Miniaturization of circuit boards", "Low power consumption of set" and "Robust operation" are important factors. Toshiba's proposals are based on these three solution perspectives.



# Device solutions to address customer needs





Absorbs static electricity (ESD) from external terminals, prevents circuit malfunction and protects devices.

### High ESD pulse absorption performance

Improved ESD absorption compared to our conventional products. (50 % reduction in operating resistance) For some products, both low operating resistance and low capacitance are realized and ensures high signal protection performance and signal quality.



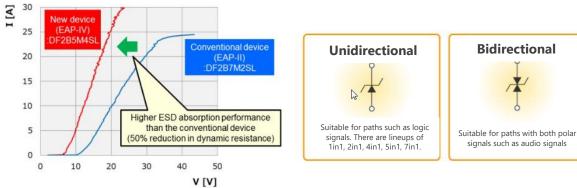
Protect the connected circuits/devices using Toshiba own technology.



Suitable for high density mounting

A variety of small packages are available.





### Lineup

Part number	DF2B6M4SL	DF2B6M4BSL	DF2B20M4SL	DF2B5BSL	DF2B5PCT	DF2B7PCT
Package		SI	,	CST2 💊		
V <sub>ESD</sub> [kV]	±20	±8	±15	±23	±30	±30
V <sub>RWM</sub> (Max) [V]	5.5	5.5	18.5	3.3	3.6	5.5
C <sub>t</sub> (Typ.) [pF]	0.2	0.12	0.2	11	41	45
R <sub>DYN</sub> (Typ.) [Ω]	0.5	1.05	0.2	0.2	0.1	0.1
Purpose	Signal line	Signal line	Signal line Power line	Power line	Power line	Power line Audio line

(Note) This product is an ESD protection diode and cannot be used for purposes other than ESD protection.



Suitable for power management, contributes to miniaturization



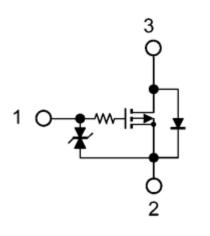
Operates down to  $V_{GS} = 1.2 V$  (SSM3J64CTC)



### Low on-resistance

By reducing drain and source on-resistance, heat radiation and power dissipation is minimized.





### Lineup

Part number	SSM3J64CTC	SSM3K16CTC	
Package	сรтзс	сятас 🐼	
R <sub>DS(ON)</sub> (Typ.) [Ω] @  V <sub>GS</sub> = 2.5 V	0.4	2.1	
I <sub>D</sub> [A]	-1	0.2	
V <sub>DSS</sub> [V]	-12	20	
V <sub>GSS</sub> [V]	±10	±10	
Polarity	P-ch	N-ch	





Fast, low loss, small package and suitable for many applications

Ta = 75 °C

50 °C

25 °C

0°C

-25 °C

15

20

10

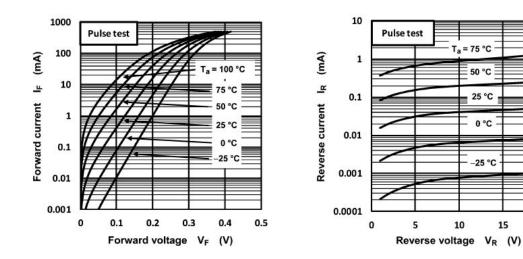
# Fast switching

### Suitable for fast switching applications.



### Small package

Encapsulated in a CST2 type package.



Lineup	
Part number	CTS05S30
Package	CST2
I <sub>O</sub> [A]	0.5
V <sub>R</sub> [V]	20
V <sub>F</sub> (Typ.) [V] @I <sub>F</sub> = 0.1 A	0.28
I <sub>R</sub> (Max) [mA] @V <sub>R</sub> = 10 V	0.15



Wide lineup from general purpose type to small package type are provided. Contribute to realize a stable power supply not affected by fluctuation of battery.

Low dropout voltage

The originally developed latest process significantly improved the dropout voltage characteristics.



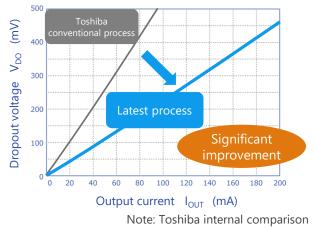
Many product series that realize both high PSRR (Power Supply Rejection Ratio) and low output noise voltage characteristics are provided. They are suitable for stable power supply for analog circuit.



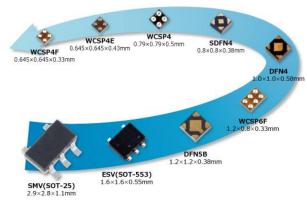
Low current consumption

0.34  $\mu$ A of I<sub>B(ON)</sub> is realized by utilizing CMOS process and unique circuit technology. (TCR3U Series)

### Low dropout voltage



### **Rich package lineup**



Lineup									
Part number	TCR15AG Series	TCR13AG Series	TCR8BM Series	TCR5BM Series	TCR5RG Series	TCR3RM Series	TCR3U Series	TCR2L Series	TAR5 Series
Features	Low dropout voltage High PSRR			Low Low c	PSRR noise urrent mption		urrent nption	15 V Input voltage Bipolar type	
I <sub>OUT</sub> (Max) [A]	1.5 1.3 0.8 0			.5	0.	.3		0.2	
PSRR (Typ.) [dB] @f = 1 kHz	95	90	98	98	100	100	70	-	70
I <sub>B</sub> (Typ.) [μΑ]	25	56	20	19	7	7	0.34	1	170

Eliminating the interface gap between host and display/camera allows more options of component selection.

# Wider component selection

Conversion of the interface allows shared procurement with other products as well as adoption of less inexpensive parts.

Camera

# Noise immunity

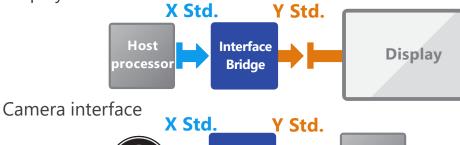
Converting parallel communication to serial improves noise tolerance and suppresses noise generation to the surroundings.



### Less cabling

Converting from parallel communication to serial reduces total number of wires and the risks of wire breakage.

### Display interface



Interface Bridge Host

rocesso

Lineup							
Part number	TC358774XBG	TC358767AXBG	TC358768AXBG	TC358746AXBG			
Package	VFBGA49	VFBGA81	VFBGA72	VFBGA72			
Input	MIPI <sup>®</sup> DSI <sup>®</sup> 1.01 4Lanes x 1ch	<ul> <li>(1) MIPI<sup>®</sup> DSI<sup>®</sup> 1.01</li> <li>(2) MIPI<sup>®</sup> DPI<sup>SM</sup> 2.0</li> <li>(3) MIPI<sup>®</sup> DSI<sup>®</sup> 1.01</li> </ul>	RGB	(1) MIPI <sup>®</sup> CSI-2 <sup>®</sup> (2) Parallel 24bit			
Output	LVDS Single Link (5 pairs/link)	(1)(2) VESA DisplayPort™ 1.1a (3) MIPI® DPI <sup>SM</sup> 2.0	MIPI <sup>®</sup> DSI <sup>®</sup> 1.02	(1) Parallel 24bit (2) MIPI <sup>®</sup> CSI-2 <sup>®</sup>			





Suitable for low frequency switching and contributes to miniaturization

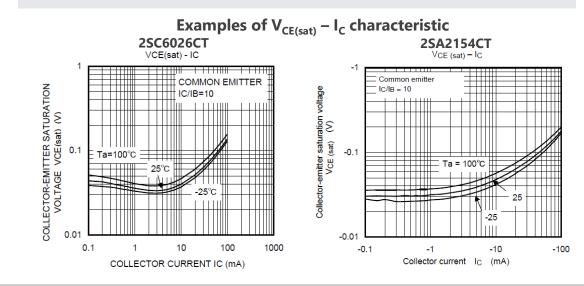
### Many package lineups

A large number of packages, such as flat lead and leadless, are available, allowing you to choose products that suit your board.



### Low collector-emitter saturation voltage

The saturation voltage between the collector and emitter is low and the power consumption is low.



Lineup		
Part number	2SC6026CT	2SA2154CT
Package	сятз 🔖	сятз 🔖
V <sub>CEO</sub> [V]	50	-50
I <sub>C</sub> [mA]	100	-100
V <sub>CE(sat)</sub> (Max) [V]	0.25	-0.3
Polarity	NPN	PNP

High Small size Noise efficiency packages mmunity Low loss

### Value provided

Low current consumption type and low noise type operational amplifiers maximize the performance of system.

Low voltage operation

We have a lineup of low power supply voltage-driven operational amplifiers using CMOS process for low power supply voltage-driven wearable equipment.



Low current consumption (TC75S102F) Ι<sub>DD</sub> = 0.27 [μA] (Typ.)

CMOS processes have been used to achieve lower current consumption. This contributes to lower power consumption and longer life of wearable equipment.



### Low noise (TC75S67TU) V<sub>NI</sub> = 6.0 [nV/√Hz] (Typ.) @f = 1 kHz

This CMOS operational amplifier can amplify minute signals detected by various sensors [Note] with very low noises. By optimizing the process, the equivalent input noise voltage has been reduced.

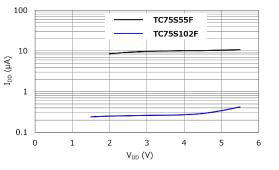
[Note] Sensor types: vibration, shock, acceleration, pressure, infrared, temperature, etc.

### TC75S102F

**TC75S67TU** 

**Current Consumption Characteristic** (Toshiba internal comparison)

### Low current consumption product TC75S102F

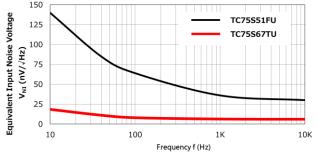




(Toshiba internal comparison)

Reduce 1/f noise (10 Hz) by 86 % from our normal products





	Lineup		
	Part number	TC75S102F	TC75S67TU
ts	Package	SMV 📌	UFV 🔶
	V <sub>DD</sub> - V <sub>SS</sub> [V]	1.5 to 5.5	2.2 to 5.5
	V <sub>IO</sub> (Max) [mV]	1.3	3
	CMV <sub>IN</sub> (Max) [V]	V <sub>DD</sub>	1.4 (@V <sub>DD</sub> = 2.5 V)
	I <sub>DD</sub> (Typ. / Max) [μA]	0.27 / 0.46 (@V <sub>DD</sub> = 1.5 V)	430 / 700 (@V <sub>DD</sub> = 2.5 V)
	$V_{NI}$ (Typ.) [nV/ $\sqrt{Hz}$ ] @f = 1 kHz	-	6



Small size packages Low loss Noise

### Value provided

Electronic fuse (eFuse IC) can be used repeatedly to protect circuits from abnormal conditions such as overcurrent and overvoltage.

# Can be used repeatedly

When overcurrent flows through the electronic fuse (eFuse IC), the internal detection circuit operates and switches off the internal MOSFET. It is not destroyed by a single overcurrent and can be used repeatedly.



Toshiba's eFuse ICs are certified to the international safety standard IEC 62368-1 (G9: Integrated circuit (IC) current limiters) and contribute to robust protection and simplification of circuit design.



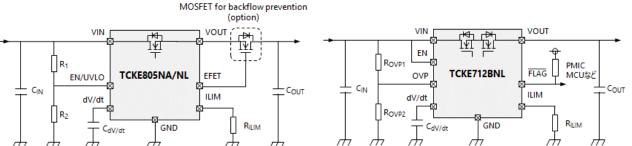
### **Rich protection functions**

TCKE8 Series: short-circuit protection, overcurrent protection, overcurrent clamp function, overvoltage clamp function, thermal shut down, inrush current suppression, backflow prevention (optional), etc.

TCKE7 Series: short-circuit protection, overcurrent protection, overvoltage protection, thermal shut down, FLAG signal output, backflow prevention (built-in), etc.

### **Reference circuit example of TCKE8 Series**

### **Reference circuit example of TCKE7 Series**



Lineup				
Part number	TCKE800NA/NL	TCKE712BNL		
Package	WSO 3.0 x 3.0 x	WSON10 3.0 x 3.0 x 0.75 mm		
V <sub>IN</sub> [V]		4.4 to 13.2		
R <sub>on</sub> (Typ.) [mΩ]		53		
Return function	N NL: Latch	Latch type (external signal control)		
V <sub>OVC</sub> (Typ.) [V]	-	6.04	15.1	Adjustable





It is N-ch MOSFET gate driver IC with OVP [Note 1] function. It contributes to reduction of power consumption and miniaturization of load switch circuit.

### Three types of N-ch MOSFET can be driven

The following types of MOSFET can be driven : TCK40xG : Single high side connection Common source connection TCK42xG : Single high side connection Common drain connection



Operating voltage V<sub>opr</sub> : 2.7 to 28 V Maximum input voltage : 40 V  $V_{IN OVLO}$  [Note 3] lineups suitable for 5 to 24V power supply line.

> [Note 2] OVLO : Over Voltage Lock Out [Note 3] V<sub>IN OVLO</sub> : V<sub>IN</sub> OVLO threshold

[Note 1] OVP : Over Voltage Protection

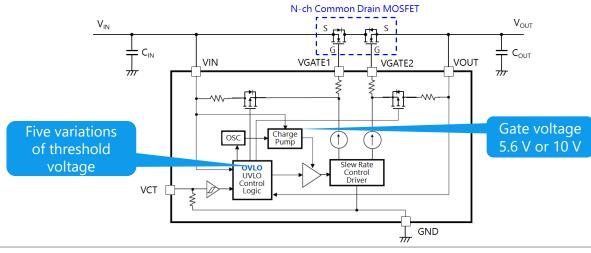


### Small packages

It contributes to reduction of the mounting area and miniaturization of the circuit board :

WCSP6E : 1.2 x 0.8 mm, t : 0.55 mm WCSP6G : 1.2 x 0.8 mm, t : 0.35 mm

### Circuit example of TCK42xG with N-ch common drain connection MOSFET



Lineup					
Part number	V <sub>IN_OVLO</sub> Min / Max [V]	V <sub>GS</sub> Typ. / Max [V]	N-ch MOSFET type can be driven	Packa	ge
TCK401G	Over 28	Max 10	Single high side	WCSP6E	
TCK402G	Over 20	$(V_{IN} \ge 12 V)$	Common Source	WCSFUE	
TCK420G	26.50 / 28.50	10 / 11			
TCK421G	22.34 / 24.05	10 / 11 (V <sub>IN</sub> ≥ 5 V)			
TCK422G	13.61 / 14.91	(VIN = 5 V)	Single high side	WCSP6G	
TCK423G	13.61 / 14.91		Common Drain	VVCSP0G	
TCK424G	10.35 / 11.47	5.6 / 6.3			
TCK425G	5.76 / 6.87				

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